NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE3065Q uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Application

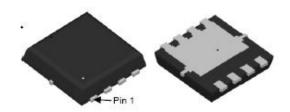
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED! 100% ΔVds TESTED!

General Features

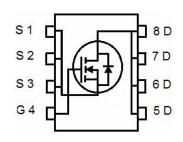
- $V_{DS} = 30V, I_{D} = 65$
 - $R_{DS(ON)}$ =4.2m Ω (typical) @ V_{GS} =10V $R_{DS(ON)}$ =6.0m Ω (typical) @ V_{GS} =4.5V
- High density cell design for ultra low Rdson
- Very low on-resistance R_{DS(on)}
- Good stability and uniformity with high E_{AS}
- 150 °C operating temperature
- Pb-free lead plating

DFN 3.3X3.3



Top View

Bottom View



Schematic Diagram

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|----------|----------------|-----------|------------|----------|
| NCE3065Q | NCE3065Q | DFN 3.3X3.3-8L | - | - | <u>-</u> |

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|------------------------|------------|------|
| Drain-Source Voltage | VDS | 30 | V |
| Gate-Source Voltage | Vgs | ±20 | V |
| Drain Current-Continuous | I _D | 65 | Α |
| Drain Current-Continuous(T _C =100 °C) | I _D (100°C) | 46 | Α |
| Pulsed Drain Current (Note 1) | I _{DM} | 260 | Α |
| Maximum Power Dissipation | P _D | 45 | W |
| Derating factor | | 0.36 | W/℃ |
| Single pulse avalanche energy (Note 5) | Eas | 150 | mJ |
| Operating Junction and Storage Temperature Range | T_{J}, T_{STG} | -55 To 150 | °C |

Thermal Characteristic

| Thermal Resistance, Junction-to-Case ^(Note 2) | Rejc | 2.8 | °C/W |
|--|------|-----|------|



Electrical Characteristics (TC=25°Cunless otherwise noted)

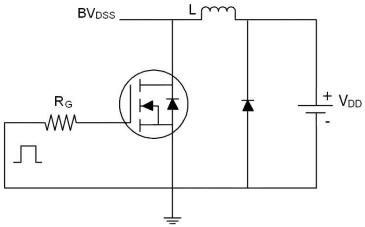
| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|---|---------------------|---|-----|------|------|----------|
| Off Characteristics | , | | ' | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250µA | 30 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =30V,V _{GS} =0V | - | - | 1 | μA |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V,V _{DS} =0V | - | - | ±100 | nA |
| On Characteristics (Note 3) | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS}=V_{GS},I_{D}=250\mu A$ | 1 | 1.5 | 2.2 | V |
| Desir Course On State Besisten | | V _{GS} =10V, I _D =20A | - | 4.2 | 5.5 | |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =4.5V, I _D =20A | - | 6.0 | 8.0 | mΩ |
| Forward Transconductance | G FS | V _{DS} =5V,I _D =20A | 30 | - | - | S |
| Dynamic Characteristics (Note4) | | | | | | |
| Input Capacitance | Clss | \/ 45\/\/ 0\/ | - | 1784 | - | PF |
| Output Capacitance | Coss | $V_{DS}=15V,V_{GS}=0V,$ | - | 266 | - | PF |
| Reverse Transfer Capacitance | C _{rss} | F=1.0MHz | - | 212 | - | PF |
| Switching Characteristics (Note 4) | | | | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 7 | - | nS |
| Turn-on Rise Time | tr | V_{DD} =5V, I_D =20A | - | 6 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =10 V , R_{GEN} =6 Ω | - | 30 | - | nS |
| Turn-Off Fall Time | t _f | | - | 8 | - | nS |
| Total Gate Charge | Qg | \/ 45\/1 00A | - | 38.4 | - | nC |
| Gate-Source Charge | Q _{gs} | V _{DS} =15V,I _D =20A, V _{GS} =10V | - | 5.8 | - | nC |
| Gate-Drain Charge | Q_{gd} | V _{GS} -10V | - | 7.9 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =20A | - | 0.85 | 1.2 | V |
| Diode Forward Current (Note 2) | Is | | - | - | 65 | Α |
| Reverse Recovery Time | t _{rr} | TJ = 25°C, I _F = 20A | - | - | 47 | nS |
| Reverse Recovery Charge | Qrr | di/dt = 100A/µs ^(Note3) | - | - | 25 | nC |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD | | | | y LS+LD) |

Notes:

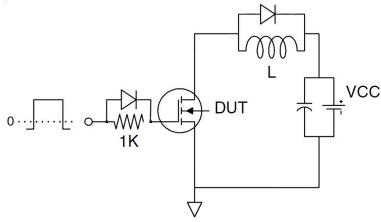
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V_{DD}=15V,V_G=10V,L=0.5mH,Rg=25 Ω

Test Circuit

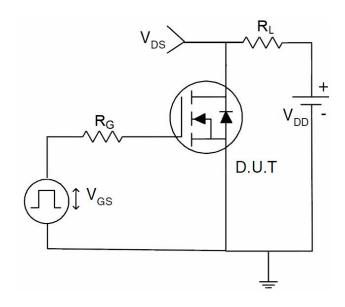
1) E_{AS} Test Circuits



2) Gate Charge Test Circuit

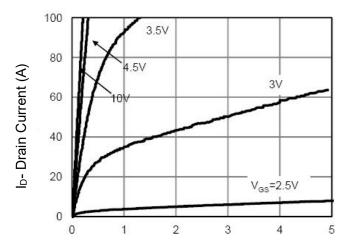


3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics

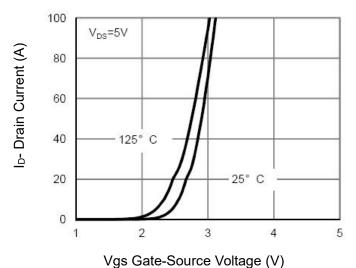


Figure 2 Transfer Characteristics

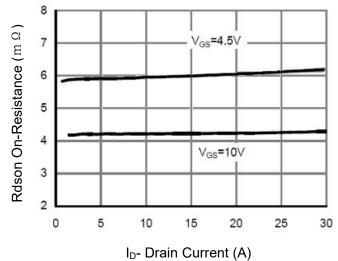


Figure 3 Rdson- Drain Current

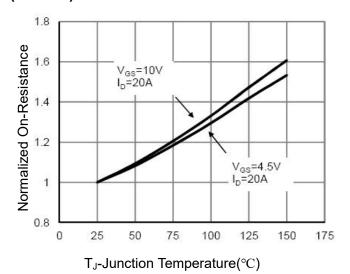


Figure 4 Rdson-Junction Temperature

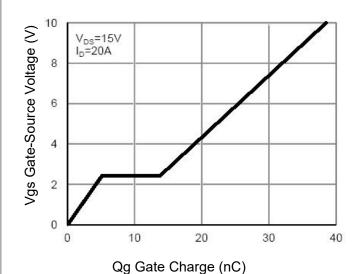


Figure 5 Gate Charge

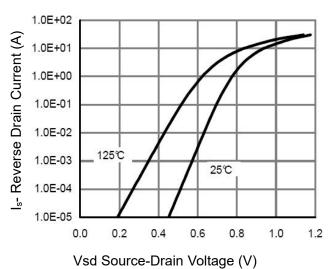
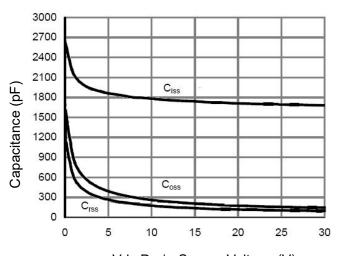


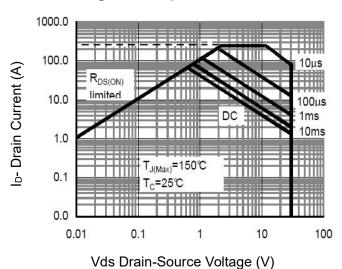
Figure 6 Source- Drain Diode Forward





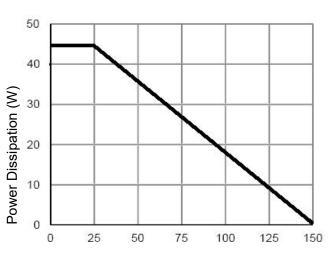
Vds Drain-Source Voltage (V)



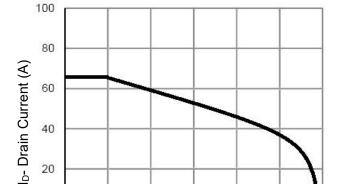


- vao Brain Goardo Vellago (V)

Figure 8 Safe Operation Area



T_J-Junction Temperature(°C) **Figure 9 Power De-rating**



T_J-Junction Temperature(°C)

50

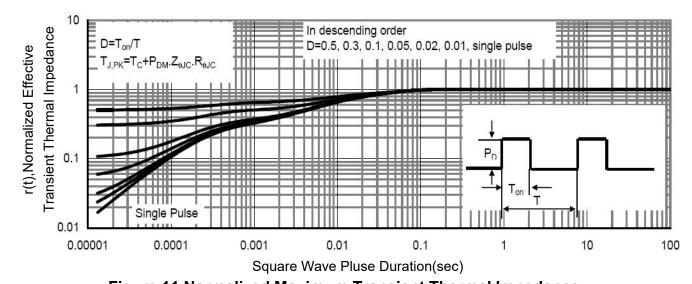
Figure 10 Current De-rating

75

100

125

150



0

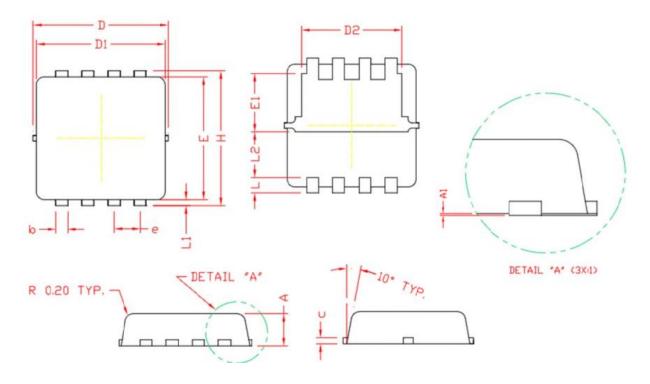
0

25

Figure 11 Normalized Maximum Transient Thermal Impedance



DFN3X3 EP Package Information



COMMON DIMENSIONS

(UNITS OF MEASURE=MILLIMETER)

| SYMBOL | MIN | NOM | MAX |
|--------|-------|----------|------|
| A | 0.70 | 0.80 | 0.90 |
| A1 | 0.00 | 0.03 | 0.05 |
| b | 0.24 | 0.30 | 0.35 |
| С | 0.10 | 0.15 | 0.20 |
| D | 3. 25 | 3.32 | 3.40 |
| D1 | 3.05 | 3.15 | 3.25 |
| D2 | 2.40 | 2.50 | 2.60 |
| E | 3.00 | 3.10 | 3.20 |
| E1 | 1.35 | 1.45 | 1.55 |
| е | 0 | .65 BSC | |
| Н | 3. 20 | 3.30 | 3.40 |
| L | 0.30 | 0.40 | 0.50 |
| L1 | 0.10 | 0.15 | 0.20 |
| L2 | 1 | . 13 REF | |

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